

# **Photonics Industries**

International, Inc.

## **DX Short Pulse Series Nanosecond Lasers**

www.photonix.com

Photonics Industries' DX Series short pulse nanosecond lasers provide industrial systems with the most ideal compact form factor, short pulse width<sup>1</sup> (down to  $\sim 10$  ns), high power, high repetition rate (up to 1 MHz) Q-switched DPSS laser for high production throughput and precision quality. Specially patented intracavity harmonic generation, with no damaging indexing on the harmonic crystals, allows for higher performance and higher reliability, fulfilling demanding production criteria.



- Cutting, drilling, welding, scribing, marking, intra-marking, patterning, dielectric grooving, de-paneling, annealing, repair
- Reel to reel on-the-fly Converting • Process Micromachining
- PCB/FPCB cutting, drilling, de-۰ paneling
- Silicon Wafer Scribing and ۰ Singulation, Low-k dielectric grooving
- Solar Cell Scribing and PERC ۰ processing
- Via Hole Drilling, Laser Trepanning, • Laser Percussion Drilling
- Laser Lift-Off (LLO), Laser • Debonding Systems, Semiconductor Microprocessing
- Selective Transfer of Light-emitting ۰ diodes (LED), µLED transfer assembly systems
- LIDAR Systems . Autonomous Systems, 3-D Scanning Systems, Airborne Laser Swath Mapping Systems, Laser Altimetry Systems

- Features Short pulse<sup>1</sup> at high powers: Up to 50 W UV, ~12 ns, Up to >80 W Green, ~14 ns
  - High pulse energy: Up to 1 mJ UV
  - Most versatile repetition rate range: Single shot up to 1 MHz Green, Single shot up to >0.5 MHz UV
  - Reliable, low COO, non-consumable design Patented intracavity harmonic UV & Green generation, no damaging indexing of the harmonic crystals
- Industrialized, small form factor, ideal for compact . integration
- Excellent TEM00 beam quality: Typical M2  $\leq$  1.1
  - Superior pulse stability: Typical < 2%
  - Total Pulse Control for ultimate integrability into systems: Duty Control to change output power while allowing for longer pulse widths than the standard operating values

PEC (Power or Pulse Energy Control)

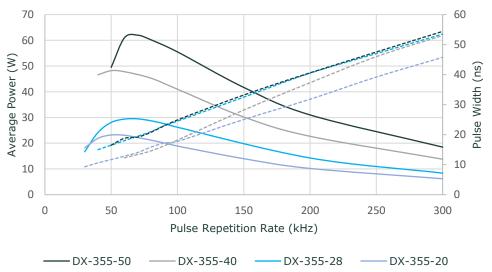
1. For longer pulse width models, please see the DX Long Pulse Series Nanosecond Lasers brochure

### Specifications - DX Series Short Pulse Nanosecond Lasers, UV Models

	DX-355-20	DX-355-28	DX-355-40	DX-355-50		
Beam <sup>5</sup> and output specific	ations					
Wavelength	355 nm					
Average power	20 W at 50 kHz	28 W at 50 kHz	40 W at 50 kHz	50 W at 50 kHz		
	18 W at 100 kHz	23 W at 100 kHz	40 W at 100 kHz	50 W at 100 kHz		
	10 W at 200 kHz	12 W at 200 kHz	25 W at 200 kHz	30 W at 200 kHz		
Pulse energy	~0.4 mJ	~0.6 mJ	~1 mJ	~1 mJ		
Pulse width	12±3 ns at 50 kHz 20±4 ns at 100 kHz					
Pulse repetition rate <sup>1</sup>	Single shot to 300 kHz (option up to >500 kHz)					
Pulse-to-pulse stability <sup>2</sup>	< 2% rms					
Long term power stability <sup>3</sup>	< ±2% rms					
Beam spatial mode	TEM <sub>00</sub> M <sup>2</sup> < 1.1 TEM <sub>00</sub> M <sup>2</sup> < 1.2					
Beam pointing stability	25 µrad					
Beam divergence	< 1.5 mrad					
Beam roundness	< 1.5 IIIau ~90%					
Beam diameter <sup>4</sup> , at exit	~0.6 mm ~2.5 mm					
Polarization ratio	Horizontal; >100:1					
Operational specifications	and system characteri		1, >100.1			
Interface	RS232, Ethernet, Software GUI, External TTL Triggering					
Warm-up time	<pre>&lt; 15 minutes from standby, &lt; 30 minutes from cold start</pre>					
Electrical requirement	100-240 V AC; or 32 V DC, 15 A					
Line frequency	50-60 Hz					
Ambient temperature	Ambient 15°C to 35°C (59°F to 95°F) Operating Range,					
Ambient temperature	Relative Humidity 90% Max., non-condensing					
Storage conditions	-10°C to 40°C; Sea Level to 12,000 m;					
	0% to 90% Relative Humidity, non-condensing					
Power consumption	< 240 W	< 320 W	< 420 W	< 600 W		
Dimensions (LxWxH)	18 x 7.5 x 3.75 in					
Weight	29 lbs (13.2 kg)					
Cooling system	Water-cooled					

[1.] Lower pulse repetition rates (down to < 30 kHz) performance achieved by pulse energy capping. [2.] Measured at ambient temperature  $\pm$  2°C. [3.] Measured over 8 hours  $\pm$  1°C. [4.] Larger beam diameters at the exit (up to ~2.5 mm) are available with the expansion option. [5] Beam parameters are specified at pulse repetition rate of 70 kHz.





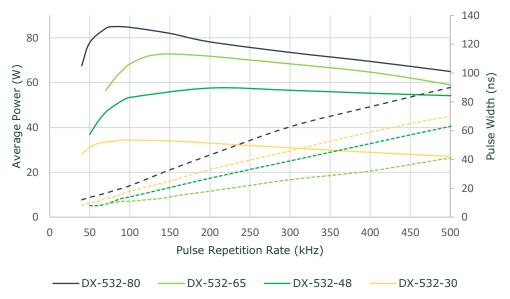


### Specifications - DX Series Short Pulse Nanosecond Lasers, GRN Models

	DX-532-30	DX-532-48	DX-532-65	DX-532-80		
Beam and output specifica	ations					
Wavelength	532 nm					
Average power	30 W, 100-200 kHz	48 W, 100-500 kHz	65 W, 100-200 kHz	>80 W, 100-200 kHz		
	27 W at 300 kHz		63 W at 300 kHz	65 W at 300 kHz		
	25 W at 400 kHz		60 W at 400 kHz	60 W at 400 kHz		
	22 W at 500 kHz		57 W at 500 kHz	55 W at 500 kHz		
Pulse energy	~0.5 mJ	~0.6 mJ	~0.7 mJ	~0.8 mJ		
Pulse width	10±2 ns at 50 kHz		14±2 ns at 100 kHz			
	< 25 ns at 200 kHz		< 25 ns at 200 kHz			
Pulse repetition rate <sup>1</sup>	Single shot to 500 kHz (option up to 1 MHz)					
Pulse-to-pulse stability <sup>2</sup>	< 2% rms					
Long term power stability <sup>3</sup>	< ±2% rms					
Beam spatial mode	$TEM_{00} M^2 < 1.1$		$TEM_{00} M^2 < 1.2$			
Beam pointing stability	< 25 µrad					
Beam divergence	< 2.5 mrad					
Beam roundness	~90%					
Beam diameter, at exit	~0.7 mm		~1 mm			
Polarization ratio	Vertical; >500:1					
<b>Operational specifications</b>	and system characteri	stics				
Interface	RS232, Ethernet, Software GUI, External TTL Triggering					
Warm-up time	< 15 minutes from standby, < 30 minutes from cold start					
Electrical requirement	100-240 V AC; or 32 V DC, 15 A					
Line frequency	50-60 Hz					
Ambient temperature	Ambient 15°C to 35°C (59°F to 95°F) Operating Range,					
	Relative Humidity 90% Max., non-condensing					
Storage conditions	-10°C to 40°C; Sea Level to 12,000 m;					
	0% to 90% Relative Humidity, non-condensing					
Power consumption	< 24	40 W	< 320 W	< 420 W		
Dimensions (LxWxH)	16 x 7.5 x 3.75 in 18 x 7.5 x 3.75 ir					
Weight	29 lbs (13.2 kg)					
Cooling system	Water-cooled					

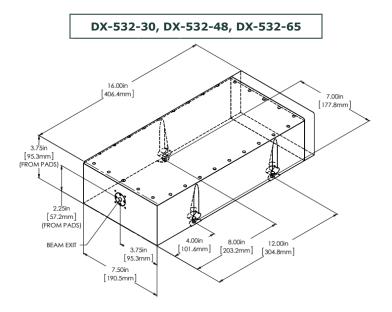
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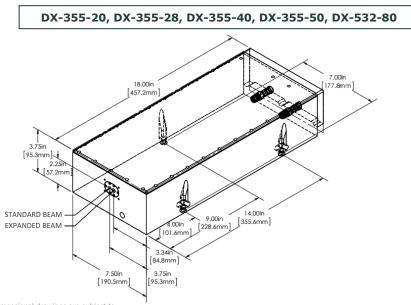






### **Dimensional Drawings**





Product specifications, characteristics, and dimensional drawings are subject to change without notice.

Photonics Industries conforms to provisions of US 21 CFR 1040.10 & 1040.11 and is made under one or more US patents listed below: 9,531,147, 8,817,831, 7,869,471, 7,346,092, 7,082,149, 7,079,557, 6,999,483, 6,980,574, 6,961,355, 6,842,293, 6,762,405, 6,690,692, 6,587,487, 6,584,134,6,366,596, 6,356,578, 6,327,281, 6,246,707, 6,229,829, 6,108,356, 6,061,370, 6,028,620, 5,936,983, 5,898,717 and Pending Patents

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Photonics Industries International is the pioneer of intracavity harmonic lasers and is at the forefront of developing, manufacturing and marketing a wide range of nanosecond, sub-nanosecond, picosecond and femtosecond lasers for industrial, scientific, defense, and medical industries. Check out our products and see how we can help you <u>apply</u> our lasers to your needs.



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# 光と人をつなぐ

# Rayture Systems



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